

	Hits	Search Text	DBs	Time Stamp
1	5	(circuit and stress and dynes) .clm.	US-PGPUB	2008/01/22 00:37
2	96	(circuit and stress and membrane) .clm.	US-PGPUB	2008/01/22 00:37
3	5	(circuit and stress with dynes and membrane) .clm.	US-PGPUB	2008/01/22 00:37
4	9	(source with drain with gate and stress and membrane) .clm.	US-PGPUB	2008/01/22 00:38
5	1	(source with drain with gate and stress and dynes) .clm.	US-PGPUB	2008/01/22 00:38
6	1	(source with drain with gate and stress with dynes) .clm.	US-PGPUB	2008/01/22 00:38
7	0	(source with drain with gate and stress with dynes and membrane) .clm.	US-PGPUB	2008/01/22 00:39
8	23	(interconnect and stress and membrane) .clm.	US-PGPUB	2008/01/22 00:39
9	6	(interconnect and stress with dynes and membrane) .clm.	US-PGPUB	2008/01/22 00:39
10	1	(data adj sink and stress and membrane) .clm.	US-PGPUB	2008/01/22 00:40
11	1	(data adj sink and stress with dynes and membrane) .clm.	US-PGPUB	2008/01/22 00:40
12	4	(circuit and stress with dynes and substrate with (remov\$3 etch\$3)) .clm.	US-PGPUB	2008/01/22 00:41
13	160	(circuit and stress and substrate with (remov\$3 etch\$3)) .clm.	US-PGPUB	2008/01/22 00:41